ALPHA & OMEGA SEMICONDUCTOR 600V, 7A N-Channel MOSFET with Fast Recovery Diode									
General Description			Product Summary						
The AOTF7N60FD has been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low R <sub>DS(on)</sub> , C <sub>iss</sub> and C <sub>rss</sub> along with guaranteed avalanche capability this part can be adopted quickly into new and existing offline power supply designs. For Halogen Free add "L" suffix to part number: AOTF7N60FDL			$V_{DS}$ I <sub>D</sub> (at V <sub>GS</sub> =10V) R <sub>DS(ON)</sub> (at V <sub>GS</sub> =10V)	700V@150℃ 7A < 1.45Ω					
			100% UIS Tested 100%  R <sub>g</sub> Tested	Rohs					
	AOTF7N60FD G D S Ratings T_=25°C unles	s otherwise n	G oted						
	D	s otherwise n		Units					
Absolute Maximum	AOTF7N60FD $G^{\text{D}}$		oted						
Absolute Maximum Parameter Drain-Source Voltage	AOTF7N60FD G D Ratings T <sub>A</sub> =25°C unles	Symbol V <sub>DS</sub>	AOTF7N60FD	Units					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unles T <sub>C</sub> =25 <sup>o</sup> C T <sub>C</sub> =100 <sup>o</sup> C	Symbol	AOTF7N60FD           600           ±30           7*           4.7*	Units V					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unles T <sub>C</sub> =25 <sup>o</sup> C T <sub>C</sub> =100 <sup>o</sup> C	Symbol V <sub>DS</sub> V <sub>GS</sub>	AOTF7N60FD           600           ±30           7*	Units V V					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup>	AOTF7N60FD $G^{\text{D}}$ Ratings $T_{\text{A}}=25^{\circ}\text{C}$ unles T <sub>C</sub> =25^{\circ}\text{C} T <sub>C</sub> =100^{\circ}\text{C} C	Symbol V <sub>DS</sub> V <sub>GS</sub>	AOTF7N60FD           600           ±30           7*           4.7*	Units V V					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche	AOTF7N60FD $G$ $D$ Ratings $T_A=25^{\circ}C$ unles $T_C=25^{\circ}C$ $T_C=100^{\circ}C$ c energy $C$	Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>D</sub> I <sub>DM</sub>	AOTF7N60FD           600           ±30           7*           4.7*           24	Units           V           V           A					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalance	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unles T_C=25^{\circ}C T_C=100^{\circ}C C energy C che energy G	Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>D</sub> I <sub>DM</sub> I <sub>AR</sub>	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5	Units           V           V           A           A					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unles T_C=25^{\circ}C T_C=100^{\circ}C c energy C che energy G dv/dt	Symbol V <sub>DS</sub> V <sub>GS</sub> 	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184	Units           V           V           A           MJ					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalance Peak diode recovery	AOTF7N60FD $G$ $D$ Ratings $T_A=25^{\circ}C$ unles $T_C=25^{\circ}C$ $T_C=100^{\circ}C$ C energy $C$ che energy $G$ dv/dt $T_C=25^{\circ}C$	Symbol           V <sub>DS</sub> V <sub>GS</sub> I <sub>D</sub> I <sub>AR</sub> E <sub>AR</sub> E <sub>AS</sub> dv/dt	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184           368	Units           V           V           A           MJ           mJ					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalance	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unles T_C=25^{\circ}C T_C=100^{\circ}C c energy C che energy G dv/dt	Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>D</sub> I <sub>DM</sub> I <sub>AR</sub> E <sub>AR</sub> E <sub>AR</sub>	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184           368           5	Units V V A A A MJ MJ V/ns					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalance Peak diode recovery Power Dissipation <sup>B</sup> Junction and Storage	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unless T_C=25^{\circ}C T_C=100^{\circ}C C energy C c energy G dv/dt T_C=25^{\circ}C T_C=100^{\circ}C C c Derate above 25^{\circ}C C Temperature Range	Symbol           V <sub>DS</sub> V <sub>GS</sub> I <sub>D</sub> I <sub>AR</sub> E <sub>AR</sub> E <sub>AS</sub> dv/dt	AOTF7N60FD 600 ±30 7* 4.7* 24 3.5 184 368 5 39	Units       V       V       A       MJ       V/ns       W					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalance Peak diode recovery Power Dissipation <sup>B</sup> Junction and Storage Maximum lead tempe purpose, 1/8" from ca	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unless T_C=25^{\circ}C T_C=100^{\circ}C C energy C c energy G dv/dt T_C=25^{\circ}C T_C=100^{\circ}C C c Derate above 25^{\circ}C C Derate above 25^{\circ}C C Temperature Range erature for soldering ase for 5 seconds	Symbol           V <sub>DS</sub> V <sub>GS</sub> I <sub>D</sub> I <sub>D</sub> I <sub>AR</sub> E <sub>AR</sub> E <sub>AS</sub> dv/dt           P <sub>D</sub>	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184           368           5           39           0.3	Units           V           V           A           MJ           W/ns           W           W/°C					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalanc Peak diode recovery Power Dissipation <sup>B</sup> Junction and Storage Maximum lead tempe purpose, 1/8" from ca Thermal Characteris	AOTF7N60FD $G^{C}$ Ratings $T_{A}=25^{\circ}C$ unless $T_{C}=25^{\circ}C$ $T_{C}=100^{\circ}C$ C energy $C$ che energy $G^{C}$ che energy $G^{C}$ the energy $G^{C}$ $T_{C}=25^{\circ}C$ Derate above $25^{\circ}C$ Temperature Range erature for soldering ase for 5 seconds stics	$\begin{array}{c c} Symbol \\ V_{DS} \\ V_{GS} \\ \hline \\ I_D \\ I_{DM} \\ I_{AR} \\ E_{AR} \\ E_{AS} \\ dv/dt \\ \hline \\ P_D \\ T_J, T_{STG} \\ T_L \end{array}$	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184           368           5           39           0.3           -55 to 150           300	Units           V           V           A           MJ           W/ns           W/°C           °C					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalance Peak diode recovery Power Dissipation <sup>B</sup> Junction and Storage Maximum lead tempe purpose, 1/8" from ca Thermal Characteris	AOTF7N60FD G D Ratings $T_A=25^{\circ}C$ unless T_C=25^{\circ}C T_C=100^{\circ}C C C C C C C C C C C C C C C C C C C	Symbol $V_{DS}$ $V_{GS}$ $I_D$ $I_{DM}$ $I_{AR}$ $E_{AR}$ $E_{AS}$ $dv/dt$ $P_D$ $T_J, T_{STG}$ $T_L$	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184           368           5           39           0.3           -55 to 150           300	Units           V           V           A           MJ           W           V/ns           W           W/°C           °C           °C           Units					
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current <sup>C</sup> Repetitive avalanche Single pulsed avalanc Peak diode recovery Power Dissipation <sup>B</sup> Junction and Storage Maximum lead tempe purpose, 1/8" from ca Thermal Characteris	AOTF7N60FD $G^{C}$ Ratings $T_{A}=25^{\circ}C$ unless $T_{C}=25^{\circ}C$ $T_{C}=100^{\circ}C$ C energy $C$ che energy $G$ dv/dt $T_{C}=25^{\circ}C$ Derate above $25^{\circ}C$ Temperature for soldering ase for 5 seconds setics arameter -Ambient $A^{D}$	$\begin{array}{c c} Symbol \\ V_{DS} \\ V_{GS} \\ \hline \\ I_D \\ I_{DM} \\ I_{AR} \\ E_{AR} \\ E_{AS} \\ dv/dt \\ \hline \\ P_D \\ T_J, T_{STG} \\ T_L \end{array}$	AOTF7N60FD           600           ±30           7*           4.7*           24           3.5           184           368           5           39           0.3           -55 to 150           300	Units           V           V           A           MJ           WJ           V/ns           W           W/°C           °C					

\* Drain current limited by maximum junction temperature.



#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC I	PARAMETERS					
		I <sub>D</sub> =10mA, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	600			
BV <sub>DSS</sub>		I <sub>D</sub> =10mA, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C		700		V
BV <sub>DSS</sub> /∆TJ	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> =10mA, V <sub>GS</sub> =0V		0.68		V/°C
I <sub>DSS</sub>	S Zero Gate Voltage Drain Current	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	μA
.033		V <sub>DS</sub> =480V, T <sub>J</sub> =125°C			100	
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ =±30V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =5V, Ι <sub>D</sub> =250μΑ	2.5	3.3	4.2	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		1.2	1.45	Ω
<b>g</b> <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =40V, I <sub>D</sub> =3.5A		7		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =7A,V <sub>GS</sub> =0V		1.03	1.6	V
I <sub>S</sub>	Maximum Body-Diode Continuous Current				7	Α
I <sub>SM</sub>	Maximum Body-Diode Pulsed Current				24	Α
DYNAMI	C PARAMETERS					
C <sub>iss</sub>	Input Capacitance		600	826	995	pF
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz	60	86	115	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		4.5	7.9	11.5	pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	2	4	6	Ω
SWITCH	ING PARAMETERS			-		
Qg	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =480V, I <sub>D</sub> =7A	15	20	25	nC
Q <sub>gs</sub>	Gate Source Charge			3.6		nC
Q <sub>gd</sub>	Gate Drain Charge			7.7		nC
t <sub>D(on)</sub>	Turn-On DelayTime			24		ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =300V, I <sub>D</sub> =7A, R <sub>G</sub> =25Ω		55		ns
t <sub>D(off)</sub>	Turn-Off DelayTime			56		ns
t <sub>f</sub>	Turn-Off Fall Time			42		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =7A,dI/dt=100A/μs,V <sub>DS</sub> =100V		76	130	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	e I <sub>F</sub> =7A,dI/dt=100A/μs,V <sub>DS</sub> =100V		0.3	0.5	μC

A. The value of R  $_{\rm BJA}$  is measured with the device in a still air environment with T  $_{\rm A}$  =25  $^{\circ}$  C.

B. The power dissipation  $P_{D}$  is based on  $T_{J(MAX)}=150^{\circ}$  C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150° C, Ratings are based on low frequency and duty cycles to keep initial  $T_J$ =25° C.

D. The R<sub>BJA</sub> is the sum of the thermal impedance from junction to case R<sub>BJC</sub> and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

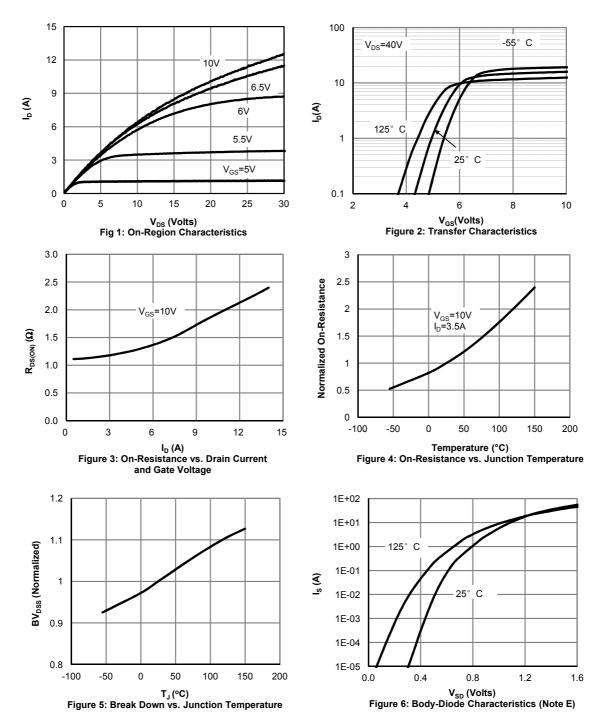
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.

G. L=60mH,  $I_{AS}$ =3.5A,  $V_{DD}$ =150V,  $R_{G}$ =25  $\Omega$ , Starting  $T_{J}$ =25° C

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### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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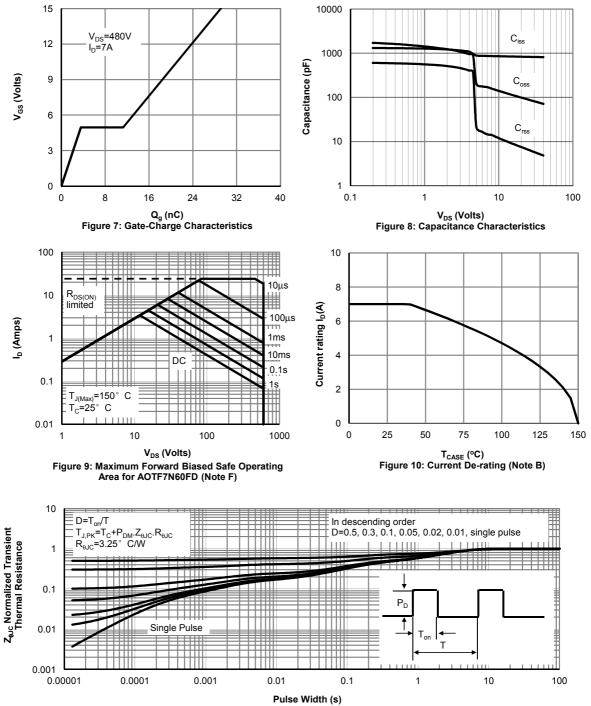
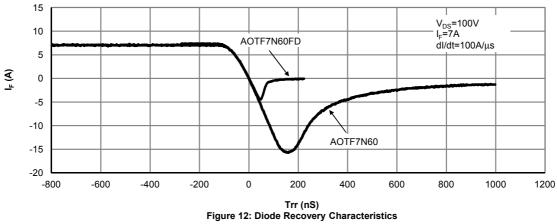


Figure 11: Normalized Maximum Transient Thermal Impedance for AOTF7N60FD (Note F)

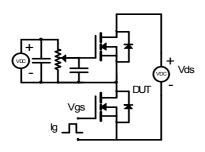


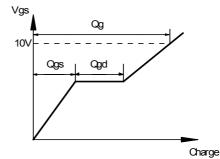
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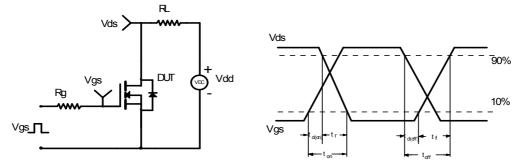


#### Gate Charge Test Circuit & Waveform

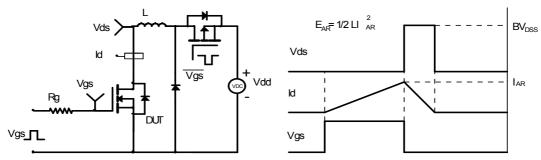




#### Resistive Switching Test Circuit & Waveforms



#### Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



# Diode Recovery Test Circuit & Waveforms

